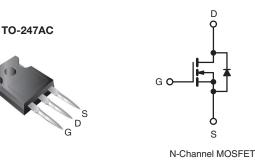


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.60			
Q _g (Max.) (nC)	140				
Q _{gs} (nC)	20				
Q _{gd} (nC)	69				
Configuration	Single				



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION				
Package	TO-247AC			
Lead (Pb)-free	IRFPC50PbF			
	SiHFPC50-E3			
SnPb	IRFPC50			
	SiHFPC50			

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	600	V	
Gate-Source Voltage			V _{GS}	± 20	v	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C		11		
		$T_{\rm C} = 100 ^{\circ}{\rm C}$	I _D	7.0	A	
Pulsed Drain Current ^a			I _{DM}	44		
Linear Derating Factor				1.4	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	920	mJ	
Repetitive Avalanche Current ^a			I _{AR}	10	A	
Repetitive Avalanche Energy ^a			E _{AR}	18	mJ	
Maximum Power Dissipation	T _C =	25 °C	PD	180	W	
Peak Diode Recovery dV/dt ^c			dV/dt	3.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
			-	1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 13 mH, $R_g = 25 \Omega$, $I_{AS} = 11$ A (see fig. 12).

c. $I_{SD} \le 11$ A, $dI/dt \le 100$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	-	40	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	-	0.24	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	0.65	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		·					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	-	0.78	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V		-	± 100	nA
	ro Gate Voltage Drain Current $I_{DSS} = \frac{V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}}{V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}}$	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	100	μA
Zero Gate Voltage Drain Current		/, V _{GS} = 0 V, T _J = 125 °C	-	-	500		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6.0 A ^b	-	-	0.60	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = 100 \text{ V}, \text{ I}_{D} = 6.0 \text{ A}^{b}$		5.7	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	2700	-	pF
Output Capacitance	C _{oss}			-	300	-	
Reverse Transfer Capacitance	C _{rss}			-	61	-	
Total Gate Charge	Qg		I _D = 11 A, V _{DS} = 360 V see fig. 6 and 13 ^b	-	-	140	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V		-	-	20	
Gate-Drain Charge	Q _{gd}			-	-	69	
Turn-On Delay Time	t _{d(on)}			-	18	-	
Rise Time	t _r	$V_{DD} = 300 \text{ V}, \text{ I}_D = 11 \text{ A},$ $\text{R}_\text{g} = 6.2 \ \Omega, \text{ R}_\text{D} = 30 \ \Omega, \text{ see fig. } 10^\text{b}$		-	37	-	- ns
Turn-Off Delay Time	t _{d(off)}			-	88	-	
Fall Time	t _f			-	36	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	- nH
Internal Source Inductance	L _S			-	13	-	
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	11	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	44	
Body Diode Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 11 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	1.4	V
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 11 A, dl/dt = 100 A/µs ^b		-	550	830	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	3.9	5.9	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	-on is dor	ninated b	vleand	<u> </u>	

Notes

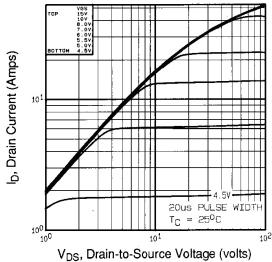
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

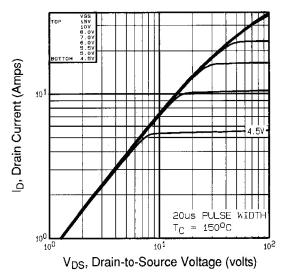


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^\circ C$

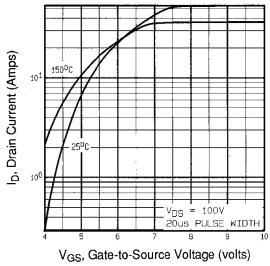


Fig. 3 - Typical Transfer Characteristics

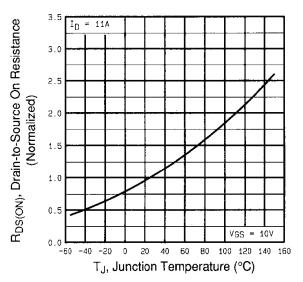


Fig. 4 - Normalized On-Resistance vs. Temperature

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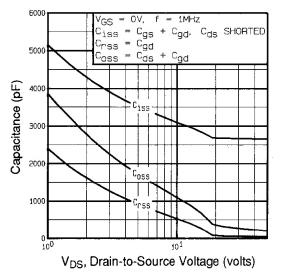


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

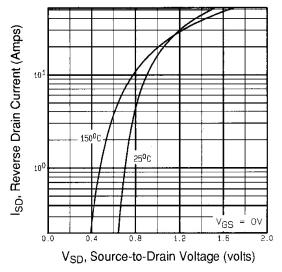


Fig. 7 - Typical Source-Drain Diode Forward Voltage

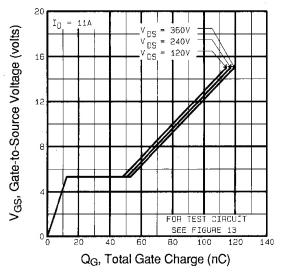
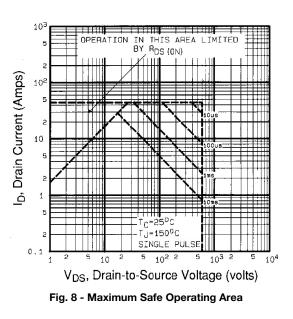


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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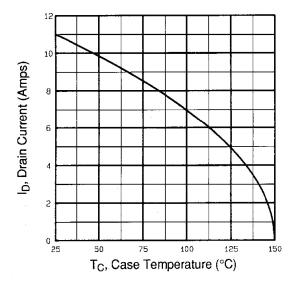


Fig. 9 - Maximum Drain Current vs. Case Temperature

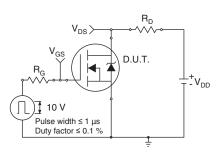


Fig. 10a - Switching Time Test Circuit

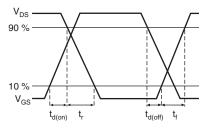


Fig. 10b - Switching Time Waveforms

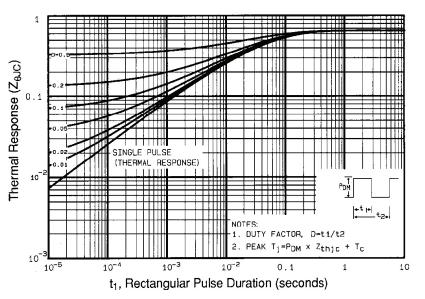


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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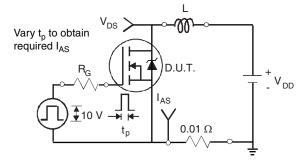


Fig. 12a - Unclamped Inductive Test Circuit

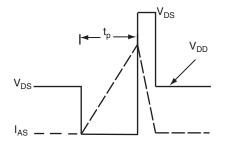


Fig. 12b - Unclamped Inductive Waveforms

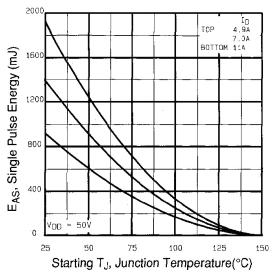
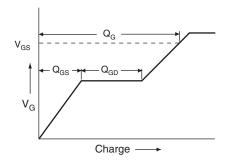


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





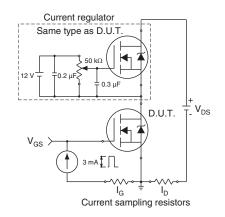
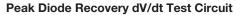


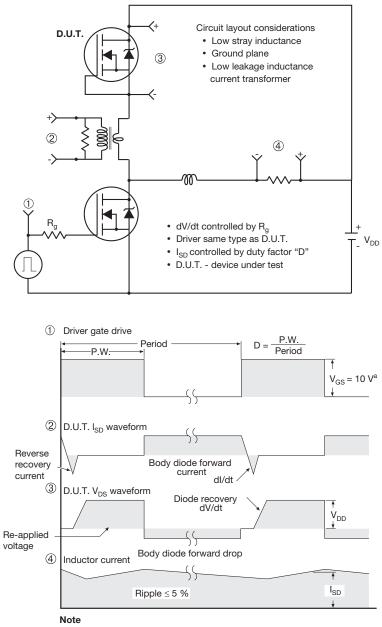
Fig. 13b - Gate Charge Test Circuit

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a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91243.

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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